

## **CALL FOR PAPERS**

#### Aim & Scope

The objective of the symposium, is to provide a forum for researchers and practitioners from industry, academia, national laboratories and government involved in the area of precision clock synchronization and distributed time-based applications.

## **Symposium topics**

We welcome paper submissions on all areas of precision clock synchronization and distributed time-based applications. Example topics of interest include but are not limited to:

#### **Distributed Applications Based on Synchronized Clocks**

- » Software, hardware, and system architecture
- » Time-based programming models
- » Design environments and tools
- » Distributed algorithms using or based on synchronized clocks
- » Robustness of distributed time-based systems
- » Fault tolerance in distributed time-based systems
- » Security in distributed time-based systems

- » Application requirements studies
- » Case studies and field experience
- » Analytic, modelling, and simulation studies
- » Time-based cyber-physical systems
- » Time synchronization for robotics and control
- » Time synchronization for cloud computing infrastructure
- » laaS Data Plane & PaaS Control/Management Plane

#### **Clock Synchronization Technology**

- » Design, usage and research concerning IEEE 1588 (PTP)
- » Systems with heterogeneous synchronization technologies
- » Synchronization performance test and evaluation tools
- » Analytic, modelling, and simulation studies
- » Clock system management
- » Timing security and robustness
- » Synchronization over gigabit fiber and wireless networks
- » Local and wide-area synchronization

- » Servo design for slave clocks
- » Device design and application support
- » Conformance testing and system integration issues
- » Time and frequency distribution
- » Smart grids, high-frequency trading, and other applications of PTP
- » Work-In-Progress reports

## **Submission of Papers**

Authors should submit a six-page original manuscript (for regular paper submissions). Submission instructions will be posted on the conference website. Papers must follow the standard IEEE Manuscript Templates for Conference Proceedings.

## Paper Acceptance

All papers will be peer-reviewed. Each accepted paper must be presented at the conference by one of the registered authors. The final manuscript must be accompanied by the registration form and proof of payment.

## **Final Papers**

Final papers are limited to six pages in IEEE double column format. Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. All full papers will be published in the conference proceedings and on *IEEE Xplore*.

May 15, 2023
Initial Paper Submission Deadline

June 19, 2023
Accept/Reject Paper Notification

July 24, 2023
Final Paper Submission Deadline



# **CALL FOR PAPERS**

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